

High Temperature Silicon Carbide Power Schottky Diode

V _{RRM}	=	650 V
V F	=	1.3 V
l _F	=	10 A
Q_{c}	=	66 nC

Features

- 650 V Schottky rectifier
- 250 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- · Superior surge current capability
- Positive temperature coefficient of V_F
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_F
- Available screened to Mil-PRF-19500

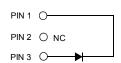
Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Package

RoHS Compliant





TO - 257 (Isolated Base-plate Hermetic Package)

Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- High Temperature DC/DC Converters
- High Temperature Motor and Servo Drives
- High Temperature Inverters
- High Temperature Actuator Control
- Military Power Supplies

Maximum Ratings at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Continuous forward current	l _F	T _C ≤ 225 °C	9.4	Α
RMS forward current	I _{F(RMS)}	T _C ≤ 225 °C	16	Α
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	T_{C} = 25 °C, t_{P} = 10 ms	140	Α
Non-repetitive peak forward current	$I_{F,max}$	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 μ s	650	Α
l ² t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	98	A^2S
Power dissipation	P _{tot}	T _C = 25 °C	208	W
Operating and storage temperature	T _i , T _{stq}		-55 to 250	°C

Electrical Characteristics at T_j = 250 °C, unless otherwise specified

Donomotor	Cumbal	Conditions -		Values		I I m i A	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	W	I _F = 10 A, T _j = 25 °C		1.34		V	
Diode forward voltage	V_{F}	I _F = 10 A, T _j = 210 °C		1.8			
Reverse current	ı	$V_R = 650 \text{ V}, T_j = 2$	25 °C		0.34	5	۸
	I _R	$V_R = 650 \text{ V}, T_j = 2$	50 °C		32	150	μΑ
Total capacitive charge	Q_{C}	$I_F \le I_{F,MAX}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	V _R = 400 V		66		nC
Switching time	ts	T _i = 210 °C	V _R = 400 V		< 49		ns
		$V_R = 1 \text{ V, } f = 1 \text{ MHz, }^{-1}$	Γ _j = 25 °C		1107		<u> </u>
Total capacitance	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz},$	T _j = 25 °C		103		pF
		$V_{P} = 800 \text{ V. } f = 1 \text{ MHz.}$	T _i = 25 °C		98		

Thermal Characteristics

i nermai resistance, junction - case	R _{thJC}	1.08	-C/VV
BALLER STORY BOOK STORY			

Mechanical Properties

Mounting torque	M	0.6	Nm

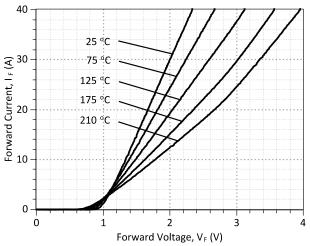


Figure 1: Typical Forward Characteristics

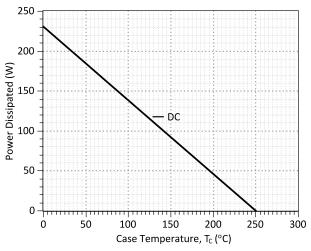


Figure 3: Power Derating Curve

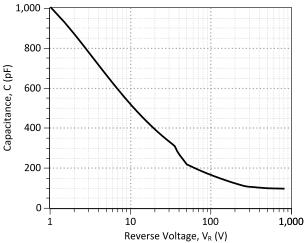


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

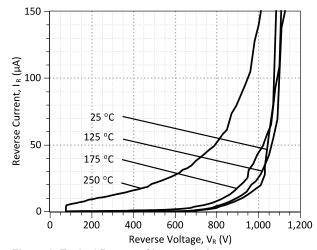


Figure 2: Typical Reverse Characteristics

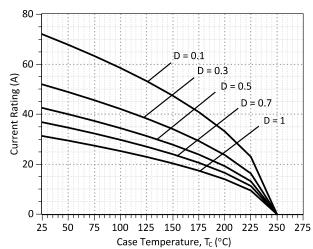


Figure 4: Current Derating Curves (D = t_P/T , t_P = 400 μ s) (Considering worst case Z_{th} conditions)

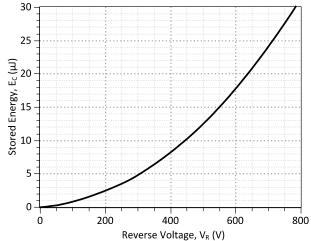


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics



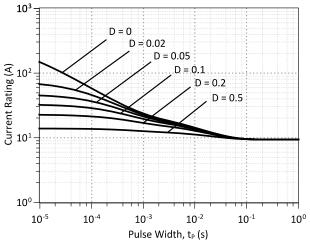


Figure 7: Current vs Pulse Duration Curves at T_c = 225 °C

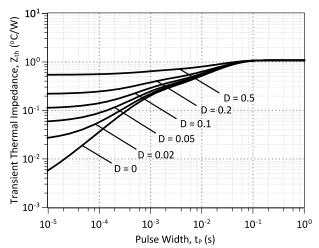
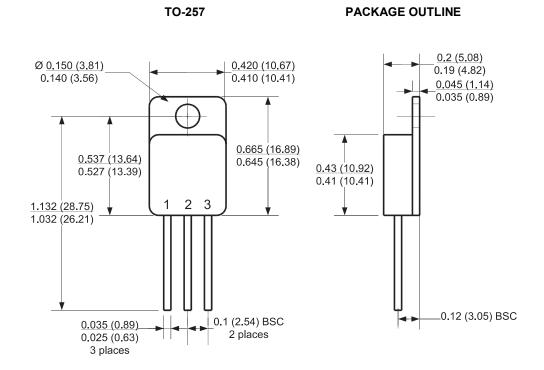


Figure 8: Transient Thermal Impedance

Package Dimensions:



- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History				
Date	Revision	Comments	Supersedes	
2012/04/24	0	Initial release		

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 1N8034-GA device.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
     $Date: 05-SEP-2013
    GeneSiC Semiconductor Inc.
    43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    httphttp://www.genesicsemi.com/index.php/sic-products/schottky
    COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of 1N8034-GA SPICE Model
.SUBCKT 1N8034 ANODE KATHODE
D1 ANODE KATHODE 1N8034 25C; Call the Schottky Diode Model
D2 ANODE KATHODE 1N8034 PIN; Call the PiN Diode Model
.MODEL 1N8034 25C D
+ IS
     8.46E-17
                         RS
                                    0.0319
         1
                                    1000
+ N
                         IKF
+ EG
         1.2
                        XTI
                                    3
+ TRS1
         0.0038
                        TRS2
                                   3.00E-05
         1.26E-09
                        VJ
+ CJO
                                   0.438
         1.5278
                                   0.5
+ M
                        FC
+ TT
         1.00E-10
                        BV
                                    800
         1.00E-03
+ IBV
                         VPK
                                    650
         20
+ IAVE
                         TYPE
                                    SiC Schottky
+ MFG GeneSiC_Semiconductor
.MODEL 1N8034 PIN D
+ IS 2.77E-10
                        RS
                                   0.086693
+ N
         3.3505
                         IKF
                                    3.67E-06
+ EG
         3.23
                        XTI
                                    -10
+ FC
         0.5
                        TT
+ BV
         800
                         IBV
                                   1.00E-03
         650
                                   20
+ VPK
                         IAVE
+ TYPE
         SiC PiN
.ENDS
```

^{*} End of 1N8034-GA SPICE Model